TOSHIBA Insulated Gate Bipolar Transistor Silicon N Channel IGBT

GT30J126

High Power Switching Applications
Fast Switching Applications

- Fourth-generation IGBT
- Enhancement mode type
- Fast switching (FS):

High speed: $t_f = 0.05 \mu s$ (typ.)

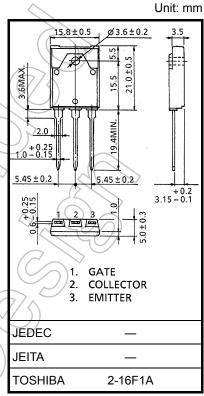
Low switching loss: $E_{on} = 1.00 \text{ mJ (typ.)}$

 $E_{off} = 0.80 \text{ mJ (typ.)}$

• Low saturation voltage: VCE (sat) = 1.95 V (typ.)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Collector-emitter voltage		V _{CES}	600	V
Gate-emitter voltage		V_{GES}	±20	V
Collector current	DC	lc <	30	
	1 ms	ICP	60	
Collector power dissipation (Tc = 25°C)		Pc	90	W
Junction temperature		(F)	150	O°C
Storage temperature range		\\\\T _{stg} \)	-55 to 150	ŶÇ



Weight: 5.8 g (typ.)

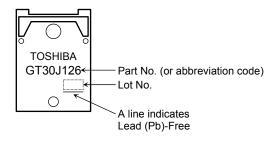
Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics	\Diamond	Symbol	Max	Unit
Thermal resistance	()	R _{th} (j-c)	1.39	°C/W

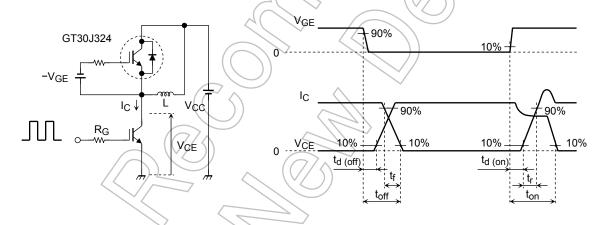
Marking



Electrical Characteristics (Ta = 25°C)

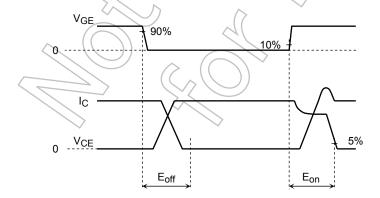
Cha	racteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	urrent	I _{GES}	V _{GE} = ±20 V, V _{CE} = 0	_	_	±500	nA
Collector cut-off	current	I _{CES}	V _{CE} = 600 V, V _{GE} = 0	_	_	1.0	mA
Gate-emitter cut	t-off voltage	V _{GE} (OFF)	I _C = 3 mA, V _{CE} = 5 V	3.5	_	6.5	V
Collector-emitte	r saturation voltage	V _{CE (sat)}	I _C = 30 A, V _{GE} = 15 V		1.95	2.45	V
Input capacitano	ce	C _{ies}	V _{CE} = 10 V, V _{GE} = 0, f = 1 MHz	(F	4650	_	pF
Switching time Rise time Turn-on tim Turn-off del Fall time	Turn-on delay time	t _{d (on)}	Inductive Load V_{CC} = 300 V, I_{C} = 30 A V_{GG} = +15 V, R_{G} = 24 Ω) 	0.09	_	- μs
	Rise time	t _r		<u> </u>	0.07	_	
	Turn-on time	t _{on}		> -	0.24	_	
	Turn-off delay time	^t d (off)		_	0.30	_	
	Fall time	t _f		_	0.05	\rightarrow	
	Turn-off time	t _{off}	(Note 1)	-6	0.43	> -	
Switching loss	Turn-on switching loss	E _{on}	(Note 2)	1	1.00) –	- mJ
	Turn-off switching loss	E _{off}		7	0.80	_	

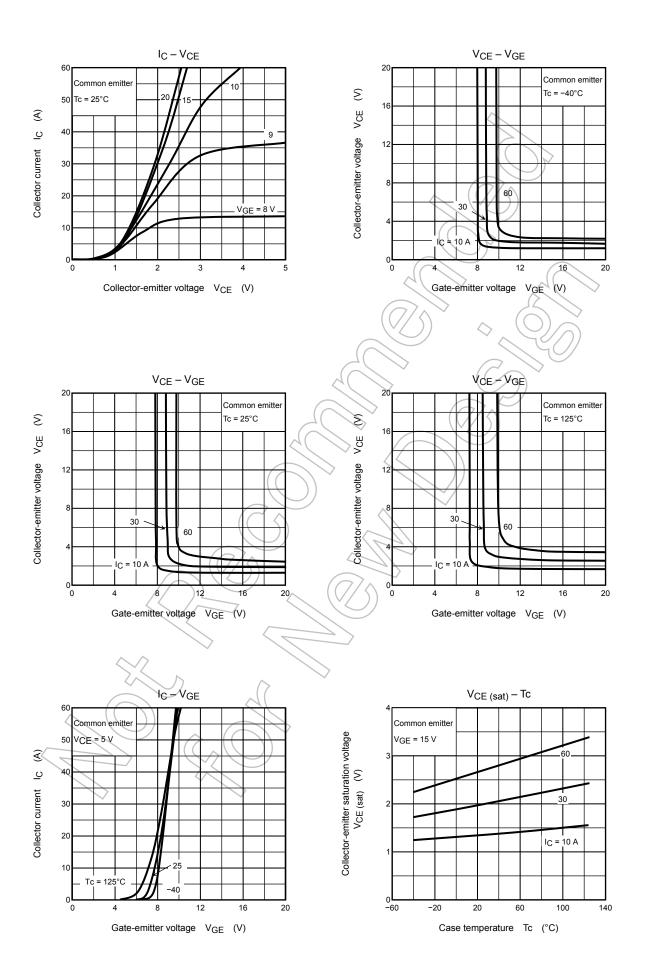
Note 1: Switching time measurement circuit and input/output waveforms

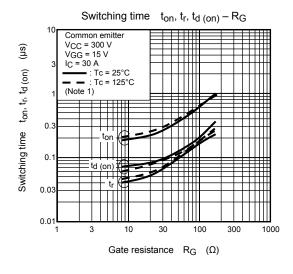


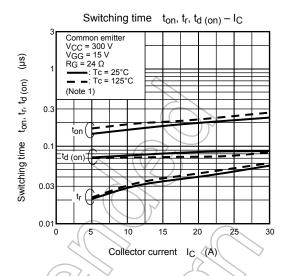
2

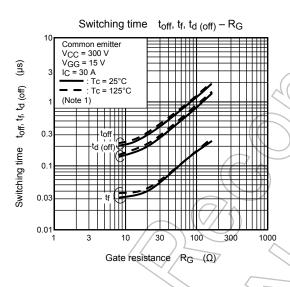
Note 2: Switching loss measurement waveforms

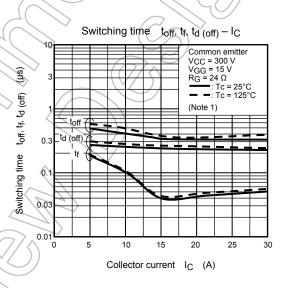


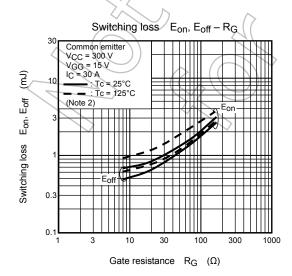


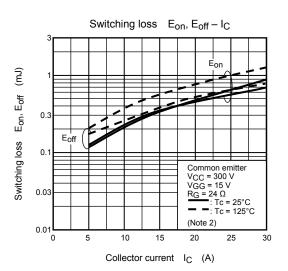


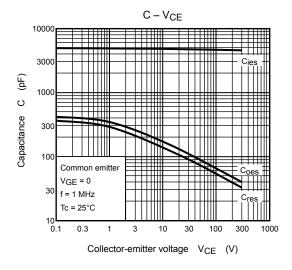


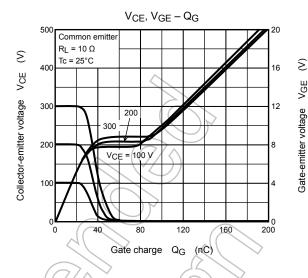


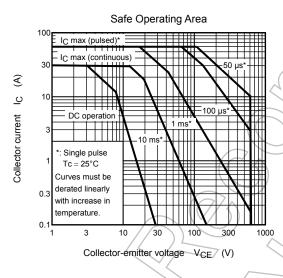


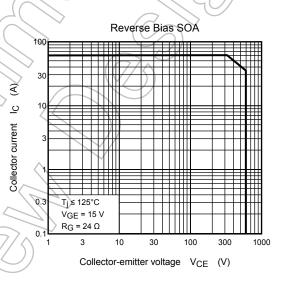


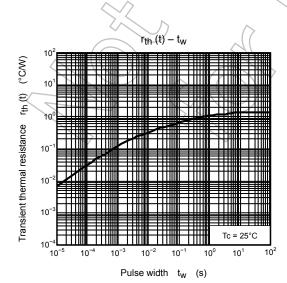












5 2008-07-29



RESTRICTIONS ON PRODUCT USE

20070701-EN GENERAL

- The information contained herein is subject to change without notice.
- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor
 devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical
 stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of
 safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of
 such TOSHIBA products could cause loss of human life, bodily injury or damage to property.
 In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as
 - In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc.
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in his document shall be made at the customer's own risk.
- The products described in this document shall not be used or embedded to any downstream products of which manufacture, use and/or sale are prohibited under any applicable laws and regulations.
- Please contact your sales representative for product-by-product details in this document regarding RoHS
 compatibility. Please use these products in this document in compliance with all applicable laws and regulations
 that regulate the inclusion or use of controlled substances. Toshiba assumes no liability for damage or losses
 occurring as a result of noncompliance with applicable laws and regulations.

6 2008-07-29